To the Honorable Commissioner of Patents:

1. Name of conveying party(ies):
   a) R. Richard Steiner
   b) Shiu-Kao Chiang

2. Name of receiving party(ies):
   GA-TEK Inc. (dba Gould Electronics Inc.)

3. Nature of conveyance:
   - [X] Assignment
   - [ ] Merger
   - [ ] Security Agreement
   - [ ] Change of Name
   - [ ] Other

   Additional name(s) of conveying party(ies) attached? [ ] Yes [X] No

   Execution Date: a) August 19, 1998; b) August 20, 1998

4. Application number(s) or patent number(s):

   If this document is being filed together with a new application, the execution date of the application is:

   A. Patent Application No.(s)
      09/132,638

   Additional numbers attached? [ ] Yes [X] No

5. Name and address of party to whom correspondence concerning document should be mailed:

   Name: Mark Kusner
   Internal Address: Mark Kusner Co., LPA
   Street Address: Highland Place - Suite 310
   6151 Wilson Mills Road
   City: Highland Heights
   State: OH
   ZIP: 44143

6. Total number of applications and patents involved: [ ]

7. Total fee (37 CFR 3.41) $ 40
   Enclosed [X] Authorized to be charged to deposit account [ ]

8. Deposit account number: 50-0537
   (Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature:
   To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

   Mark Kusner
   Name of Person Signing
   Signature
   Date 1-2-99

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

(Form PTO-1595—Recordation Form Cover Sheet—Page 3)
ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar ($1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS:

R. Richard Steiner
4158 Carroll Boulevard
University Heights, OH 44118
Nationality: USA

Shiuh-Kao Chiang
70 Franklin Street
Haworth, NJ 07641
Nationality: China

hereby sell, assign and transfer to:

ASSIGNEE:

GA-TEK Inc. (dba Gould Electronics Inc.)
34929 Curtis Boulevard
Eastlake, OH 44095-4001
An Ohio Corporation

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions and in all foreign countries, including all rights to claim priority, in and to any and all improvements which are disclosed in the invention entitled:

RESIN/COPPER/METAL LAMINATE AND METHOD OF PRODUCING SAME

and which is found in (37 C.F.R. § 3.21) U.S. application no. 09/132,638 filed on August 11, 1998 and any legal equivalent thereof in a foreign country, including the right to claim priority and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said

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application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal.

Date: 19 Aug 98

Signature of R. Richard Steiner

Date: August 20, 1998

Signature of Shiuh-Kao Chiang

(Assignment of Invention—page 2 of 2)